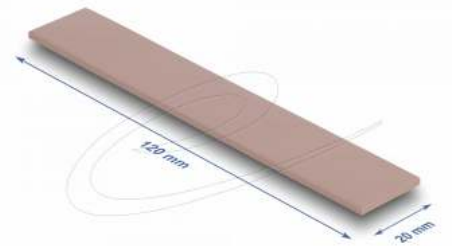


Delock Thermal Conductive Pad 120 x 20 x 2 mm for M.2 modules 3.0 W/mK - non-silicone

Description

This thermal conductive pad by Delock is suitable for heat dissipation, for example, on an M.2 module. The goal of the pad is to **improve performance and increase the service life** of the components. Typical areas of application for **silicone-free** pads can be found in industry and optoelectronics.



height 2 mm

Non-silicone

Silicone-free pads do not release any oils that could contaminate or damage sensitive components. This makes them **ideal for sensitive electronics** such as sensors. Silicone-free pads can also be used in a wider temperature range without compromising their properties, which is particularly useful in industrial applications with **extreme temperatures**. In addition to the advantage of **longer durability**, they are also **more environmentally** friendly than conventional thermal pads.

Item no. 18483

EAN: 4043619184835

Country of origin: Taiwan,
Republic of China

Package: Zip poly bag

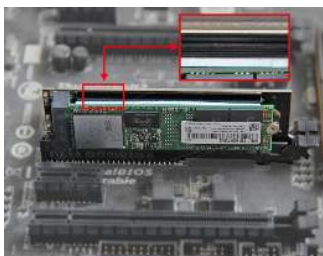
Technical details

- Thermal pad for heat dissipation
- Thermal conductivity: 3.0 W/mK
- Operating temperature: -60 °C ~ 180 °C
- Colour: pink
- Dimensions (LxWxH): ca. 120 x 20 x 2 mm

Package content

- 1 x thermal conductive pad

Images



Physical characteristics

Thermal conductivity:	3.0 W/mK
Length:	120.0 mm
Width:	20 mm
Height:	2.0 mm

Manufacturer information

Street	Beeskowdamm 13/15
Postal code	14167
City	Berlin
Country	Deutschland
E-Mail	info@delock.de
Website	www.delock.de